

High Voltage Transistor

NPN Silicon

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	300	Vdc
Collector-Base Voltage	V_{CBO}	300	Vdc
Emitter-Base Voltage	V_{EBO}	6.0	Vdc
Collector Current — Continuous	I_C	500	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	625 5.0	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.5 12	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	$^\circ\text{C/W}$

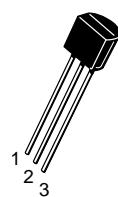
ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				

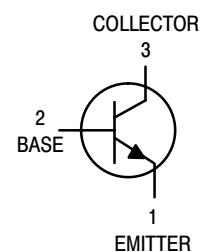
Collector-Emitter Breakdown Voltage ⁽¹⁾ ($I_C = 1.0 \text{ mAdc}, I_B = 0$)	$V_{(BR)CEO}$	300	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 100 \mu\text{Adc}, I_E = 0$)	$V_{(BR)CBO}$	300	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 100 \mu\text{Adc}, I_C = 0$)	$V_{(BR)EBO}$	6.0	—	Vdc
Collector Cutoff Current ($V_{CB} = 200 \text{ Vdc}, I_E = 0$)	I_{CBO}	—	0.1	μAdc
Emitter Cutoff Current ($V_{EB} = 6.0 \text{ Vdc}, I_C = 0$)	I_{EBO}	—	0.1	μAdc

1. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$; Duty Cycle $\leq 2.0\%$.

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CASE 29-04, STYLE 1
TO-92 (TO-226AA)



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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
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ON CHARACTERISTICS

DC Current Gain ($I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 10 \text{ V}_\text{dc}$) ($I_C = 10 \text{ mA}_\text{dc}$, $V_{CE} = 10 \text{ V}_\text{dc}$)	h_{FE}	25 40	— —	— —
Collector-Emitter Saturation Voltage ($I_C = 20 \text{ mA}_\text{dc}$, $I_B = 2.0 \text{ mA}_\text{dc}$)	$V_{CE(\text{sat})}$	—	2.0	V_dc
Base-Emitter Saturation Voltage ($I_C = 20 \text{ mA}_\text{dc}$, $I_B = 2.0 \text{ mA}_\text{dc}$)	$V_{BE(\text{sat})}$	—	2.0	V_dc

SMALL-SIGNAL CHARACTERISTICS

CurrentGain — Bandwidth Product ($I_C = 10 \text{ mA}_\text{dc}$, $V_{CE} = 20 \text{ V}_\text{dc}$, $f = 20 \text{ MHz}$)	f_T	50	—	MHz
Common Emitter Feedback Capacitance ($V_{CB} = 60 \text{ V}_\text{dc}$, $I_E = 0$, $f = 1.0 \text{ MHz}$)	C_{re}	—	2.0	pF

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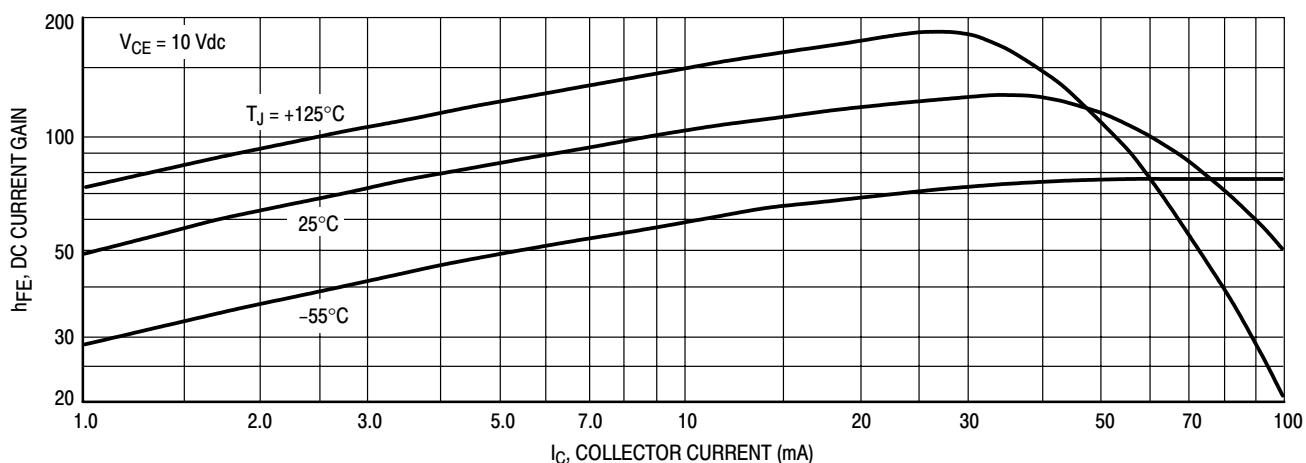


Figure 1. DC Current Gain

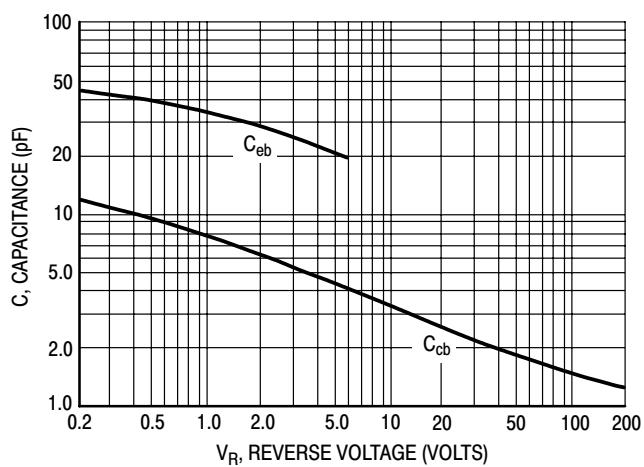


Figure 2. Capacitances

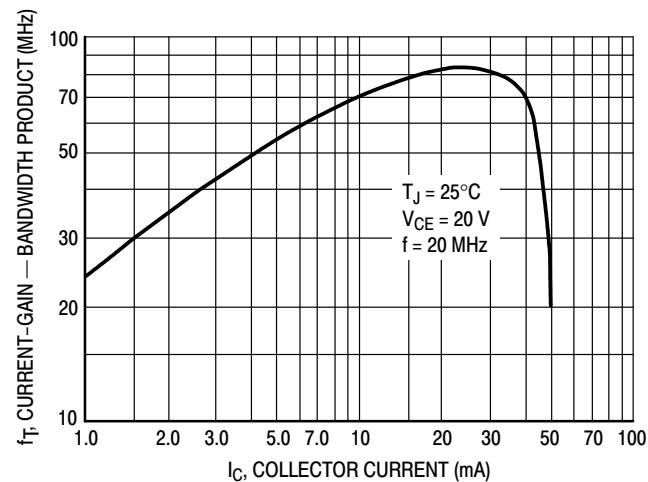


Figure 3. Current-Gain — Bandwidth Product

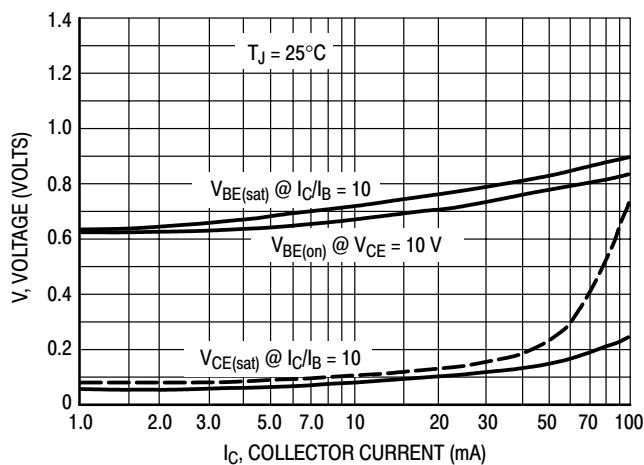


Figure 4. "On" Voltages

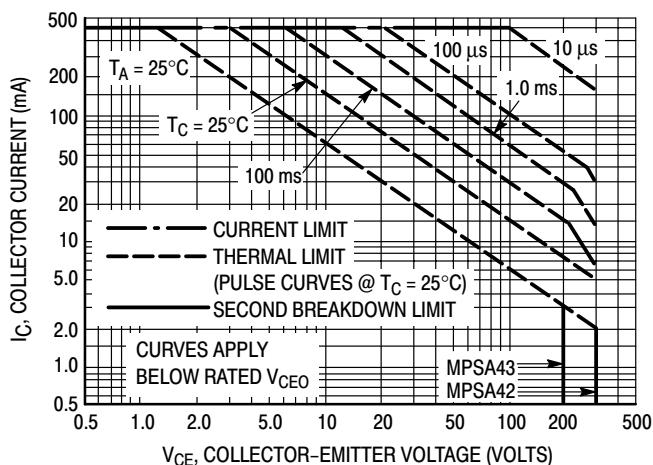


Figure 5. Maximum Forward Bias
Safe Operating Area